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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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### General Description

The MX555ANR200M000 is an ultra-low phase jitter XO with LVPECL output optimized for high line rate applications.

### Features

- 200MHz LVPECL
- Typical phase noise:
  - 96fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

### Absolute Maximum Ratings

Supply Voltage (VIN).....	+4.6V
Lead Temperature (soldering, 10s).....	260°C
Storage Temperature (T <sub>s</sub> ).....	125°C
ESD Rating (HBM).....	2kV

### Operating Ratings

Supply Voltage (VIN).....	+2.375V to +3.63V
Ambient Temperature (TA).....	-40°C to +85°C

### Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, outputs terminated with 50 Ohms to VDD - 2V.<sup>1</sup>

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
IDD	Supply Current				120	mA
F0	Center Frequency			200		MHz
	Frequency Stability	Note 2			±50	ppm
∅j	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		130 96		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		85		350	ps
	Duty Cycle		45		55	%
VOH	Output High Voltage	LVPECL output levels	VDD - 1.35	VDD - 1.01	VDD - 0.8	V
VOL	Output Low Voltage	LVPECL output levels	VDD - 2.0	VDD - 1.78	VDD - 1.6	V
Vswing	Peak to Peak Output Voltage Swing		0.65	0.77	0.95	V

- Notes:**
1. Guaranteed after thermal equilibrium.
  2. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

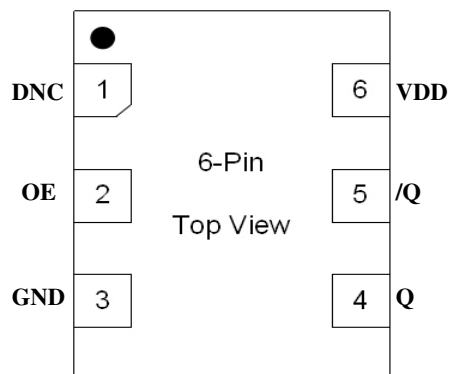
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## Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX555ANR200M000	MX555A	NR2000	Tube	6-Pin 5mm x 3.2mm LGA
MX555ANR200M000 TR	MX555A	NR2000	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

## Pin Configuration



## Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	DNC			Make no connection, leave floating.
2	OE	I, SE	LVC MOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k Ohms Pull-Up
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	LVPECL	Clock Output Frequency = 200MHz
6	VDD	PWR		Power Supply

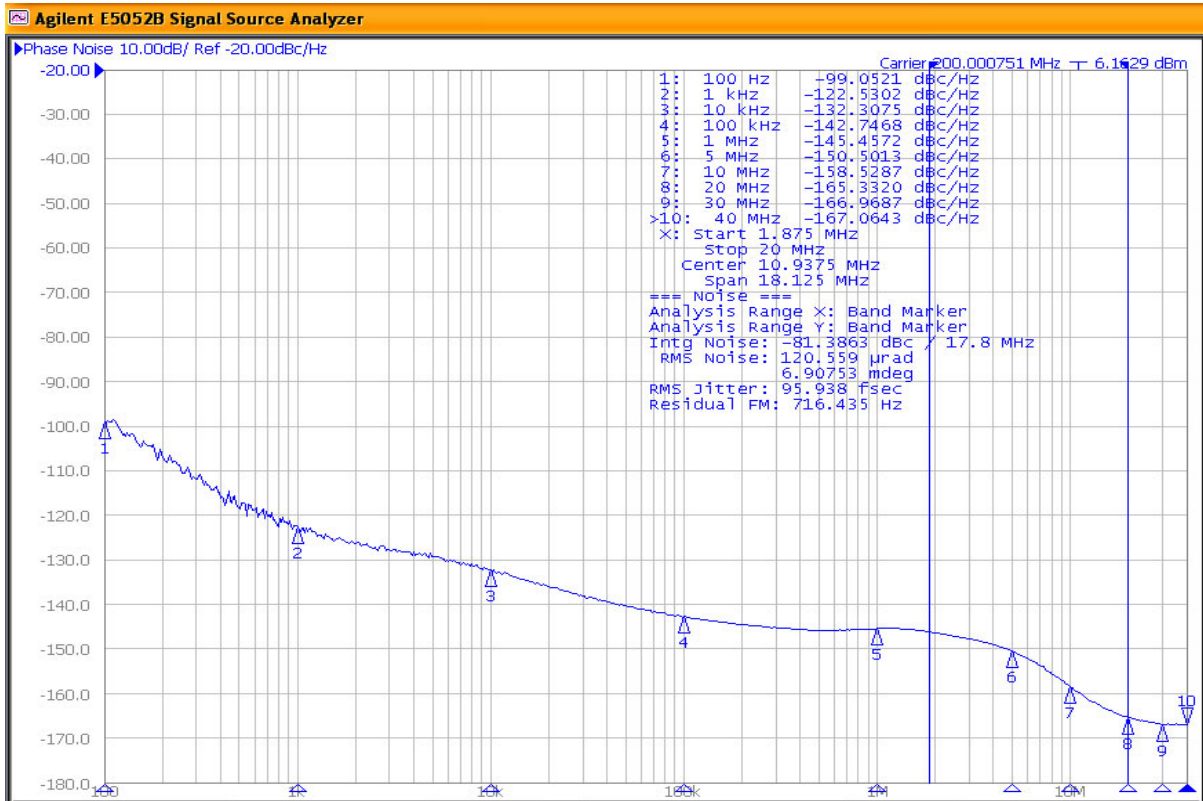


Figure 1. LVPECL Output 200MHz 1.875MHz-20MHz 96fs

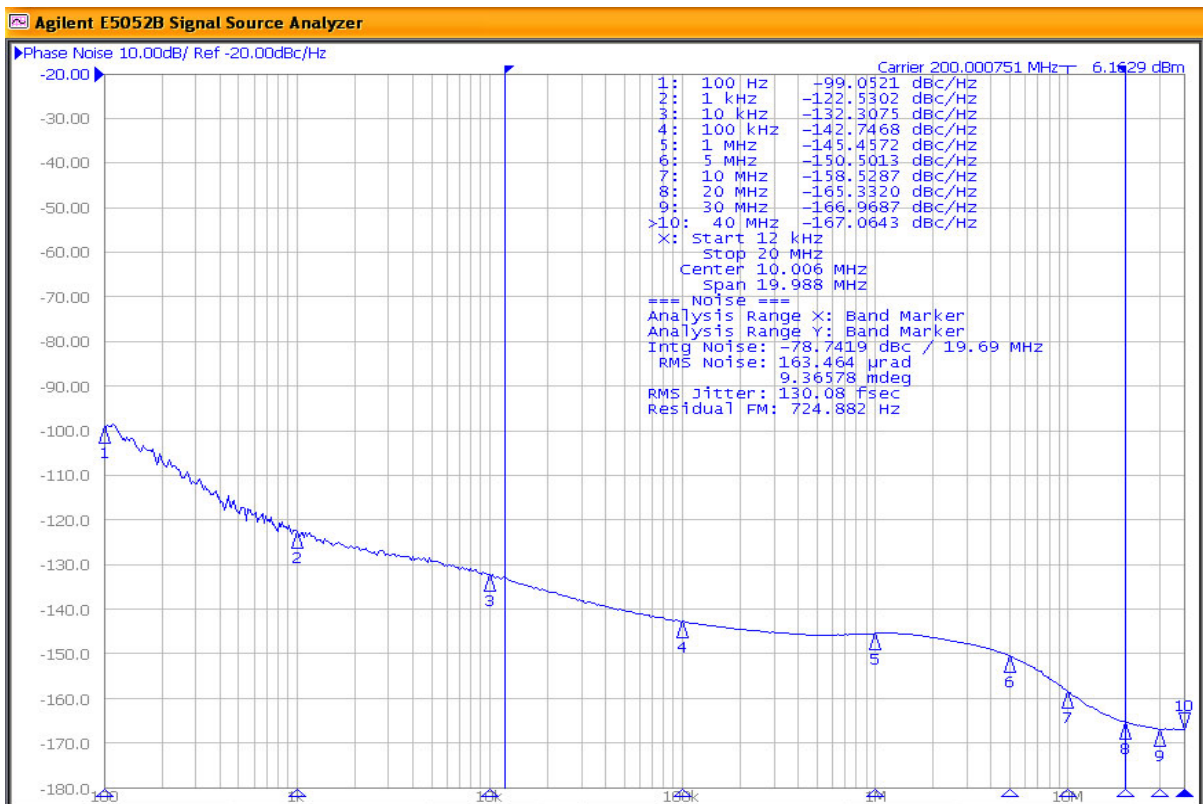
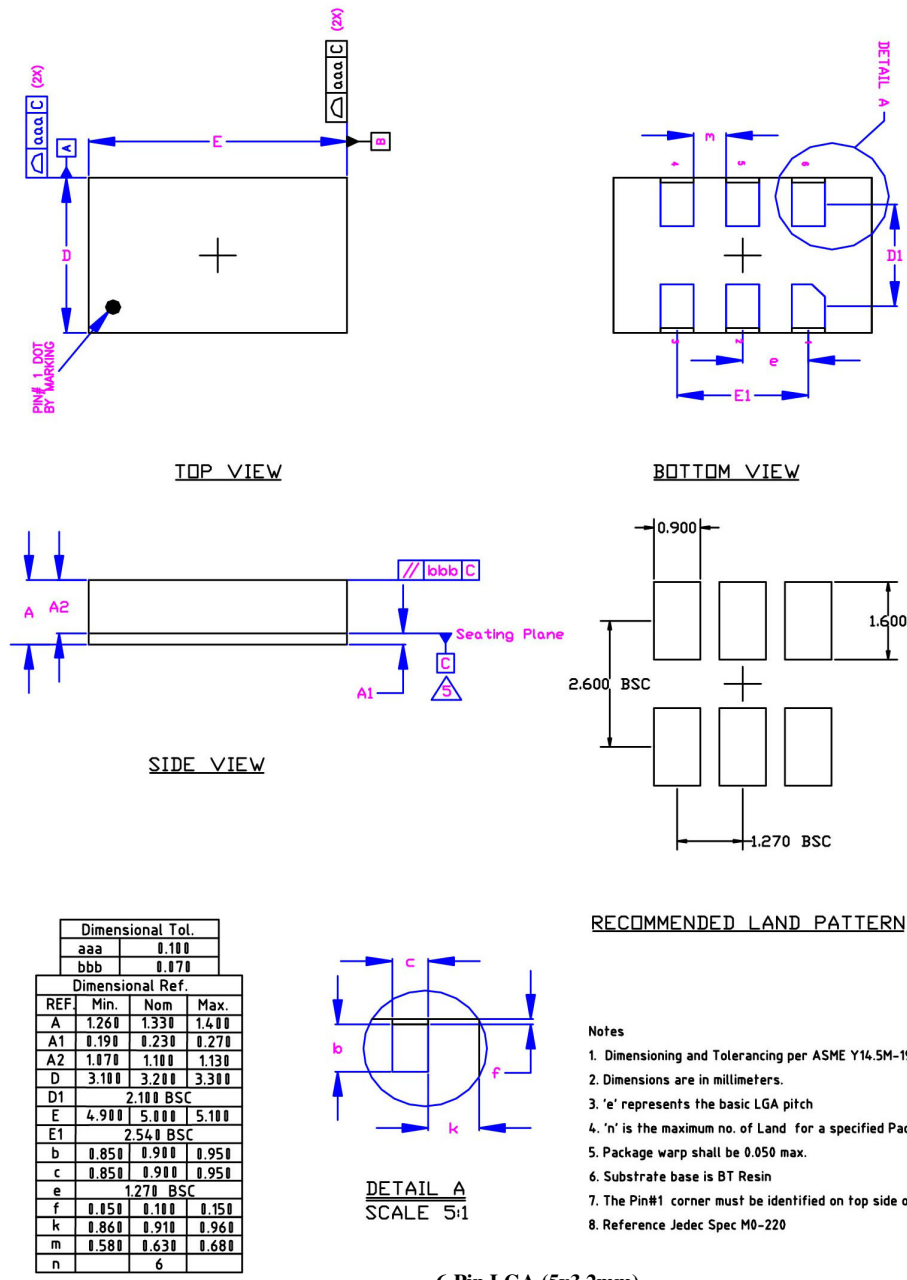


Figure 2. LVPECL Output 200MHz 12kHz-20MHz 130fs

### Package Information and Recommended Land Pattern for 6-Pin LGA<sup>3</sup>



**RECOMMENDED LAND PATTERN**

- Notes**
1. Dimensioning and Tolerancing per ASME Y14.5M-1994.
  2. Dimensions are in millimeters.
  3. 'e' represents the basic LGA pitch
  4. 'n' is the maximum no. of Land for a specified Package.
  5. Package warp shall be 0.050 max.
  6. Substrate base is BT Resin
  7. The Pin#1 corner must be identified on top side only.
  8. Reference Jecdec Spec M0-220

**Note:**

3. Package information is correct as of the publication date. For updates and most current information, go to [www.microchip.com](http://www.microchip.com).

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